

TLP702F

Intelligent power module signal isolation

Industrial inverters

Motor drive

The Toshiba TLP702F consists of a GaAlAs light-emitting diode and an integrated high-gain, high-speed photodetector. The TLP702F is suitable for isolating input control signals to intelligent power modules. This unit is a 6-pin SDIP. The TLP702F is 50% smaller than the 8-PIN DIP and meets the reinforced insulation class requirements of international safety standards. Therefore the mounting area can be reduced in equipment requiring safety standard certification.

The detector has a totem pole output stage to provide both source and sink driving. The detector IC has an internal shield that provides a guaranteed common-mode transient immunity of 10 kV/ μ s.

The TLP702F is inverter logic type. For buffer logic type, the TLP706F is in line-up.

Absolute Maximum ratings and electrical characteristics are the same as The TLP702 technical data sheets.

- Inverter logic type (totem pole output)
 - Lead(Pb)-Free
 - Guaranteed performance over temperature : $-40\sim 100^{\circ}\text{C}$
 - Power supply voltage : 4.5~20 V
 - Input current: $I_{FHL} = 5 \text{ mA (max.)}$
 - Switching time (t_{pHL} / t_{pLH}) : 600 ns (max.)
 - Common-mode transient immunity : $\pm 10 \text{ kV}/\mu\text{s}$ (min)
 - Isolation voltage : 5000 Vrms (min)
 - UL Recognized :UL1577, File No.E67349
 - Option (D4)
- TÜV Approved : DIN EN60747-5-2

No.R50033433

Maximum Operating Insulation Voltage : 1140V_{PK}

Highest Permissible Over Voltage : 8000V_{PK}

(Note) : When a EN60747-5-2 approved type is needed,

Please designate "Option(D4)"

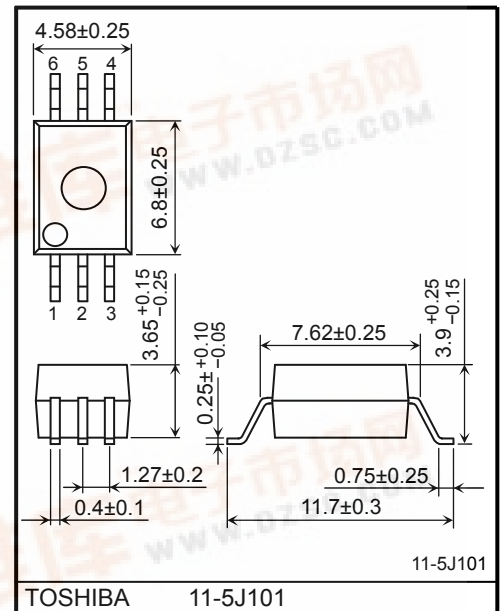
- Construction Mechanical Rating

Creepage Distance	8.0 mm (min)
Clearance	8.0 mm (min)
Insulation Thickness	0.4 mm (min)

Truth Table

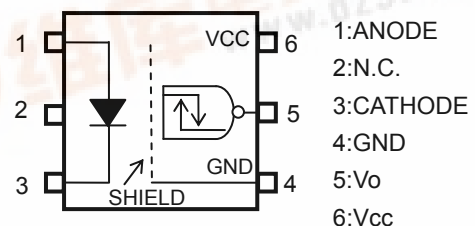
Input	LED	Tr1	Tr2	Output
H	ON	OFF	ON	L
L	OFF	ON	OFF	H

Unit in mm

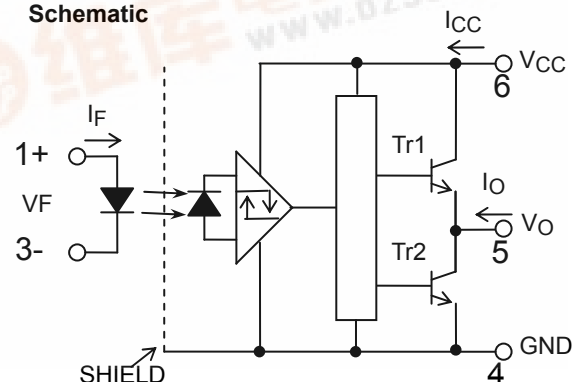


Weight:0.26 g (typ.)

Pin Configuration (Top View)



Schematic



0.1 μ F bypass capacitor must be connected between pins 6 and 4. (Note 4)

RESTRICTIONS ON PRODUCT USE

20070701-EN

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